## feATURES

- Wide Input Range: 5.5V to 60V
- 1.5A Peak Switch Current
- Constant 200kHz Switching Frequency
- Saturating Switch Design: $0.2 \Omega$
- Peak Switch Current Rating Maintained Over Full Duty Cycle Range
■ Low Effective Supply Current: 2.5mA
- Low Shutdown Current: 25 A
- 1.2V Feedback Reference Voltage (LT1766)
- 5V Fixed Output (LT1766-5)
- Easily Synchronizable
- Cycle-by-Cycle Current Limiting
- Small 16-Pin SSOP and Thermally Enhanced TSSOP Packages


## APPLICATIONS

- High Voltage, Industrial and Automotive
- Portable Computers
- Battery-Powered Systems
- Battery Chargers
- Distributed Power Systems


## DESCRIPTIOn

The LT ${ }^{\circledR} 1766 / \mathrm{LT} 1766-5$ are 200 kHz monolithic buck switching regulators that accept input voltages up to 60V. A high efficiency $1.5 \mathrm{~A}, 0.2 \Omega$ switch is included on the die along with all the necessary oscillator, control and logic circuitry. A current mode control architecture delivers fast transient response and excellent loop stability.

Special design techniques and a new high voltage process achieve high efficiency over a wide input range. Efficiency is maintained over a wide output current range by using the output to bias the circuitry and by utilizing a supply boost capacitor to saturate the power switch. Patented circuitry* maintains peak switch current over the full duty cycle range. A shutdown pin reduces supply current to $25 \mu \mathrm{~A}$ and the device can be externally synchronized from 228 kHz to 700kHz with logic level inputs.

The LT1766/LT1766-5 are available in a 16-pin fused-lead SSOP package or aTSSOP package with exposed backside for improved thermal performance.
$\overline{\boldsymbol{\Sigma}}$, LTC and LT are registered trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners. *Protected by U.S. Patents including 6498466, 6531909

## TYPICAL APPLICATION

5V Buck Converter

*FOR INPUT VOLTAGES BELOW 7.5V, SOME RESTRICTIONS MAY APPLY ${ }^{\dagger}$ TDK C4532X7R2A225K


1766 TA02

## ABSOLUTE MAXIMUM RATINGS

(Note 1)
Input Voltage (VIN) ............................................... 60V
BOOST Pin Above SW ........................................... 35V
BOOST Pin Voltage ................................................ 68V
SYNC, SENSE Voltage (LT1766-5) .......................... 7V
SHDN Voltage ......................................................... 6V
BIAS Pin Voltage .................................................. 30V
FB Pin Voltage/Current (LT1766) ................... 3.5V/2mA

Operating Junction Temperature Range
LT1766EFE/LT1766EFE-5/LT1766EGN/
LT1766EGN-5 (Note 8,10) ................. $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
LT1766IFE/LT1766IFE-5/
LT1766IGN/LT1766IGN-5 (Note 8,10) $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
LT1766HGN/LT1766HFE ................... $-40^{\circ} \mathrm{C}$ to $140^{\circ} \mathrm{C}$
Storage Temperature Range ................ $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec )................. $300^{\circ} \mathrm{C}$

## PACKAGE/ORDER InFORMATION

| TOP VIEW |  | TOP VIEW |  |
| :---: | :---: | :---: | :---: |
| GND 1 | 16 GND | $\text { GND } 1$ | 16 GND |
| sw 2 | 15 SHDN | $\text { SW } 2$ | 15 SHDN |
| NC 3 | 14 SYNC |  | 14 SYNC |
| $\mathrm{V}_{\text {IN }} 4$ | 13 NC | NC 3 <br>  4 <br> 1  | 13 NC |
| NC 5 | $12 \mathrm{Fb} / \mathrm{SENSE}$ | NC 5 | $12 \mathrm{Fb} / \mathrm{SENSE}$ |
| BOOST 6 | $11 \mathrm{~V}_{\mathrm{C}}$ | BOOST 6 | $11 V_{C}$ |
| NC 7 | 10 BIAS | NC 7 | 10 BIAS |
| GND 8 | 9 GND | GND 8 | 9 GND |
| FE PACKAGE 16-LEAD PLASTIC TSSOP |  | GN PACKAGE <br> 16-LEAD PLASTIC SSOP |  |
| $\theta_{\mathrm{JA}}=45^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JC}}(\mathrm{PAD})=10^{\circ} \mathrm{C} / \mathrm{W}$ <br> EXPOSED PAD (PIN 17) IS GND, MUST BE CONNECTED TO PCB |  | $\theta_{\mathrm{JA}}=85^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\mathrm{JC}}($ PIN 8$)=25^{\circ} \mathrm{C} / \mathrm{W}$FOUR CORNER PINS SOLDERED TO GROUND PLANE |  |
| ORDER PART NUMBER | FE PART MARKING | ORDER PART NUMBER | GN PART MARKING |
| LT1766EFE | 1766EFE | LT1766EGN | 1766 |
| LT1766IFE | 1766IFE | LT1766IGN | 1766\| |
| LT1766HFE | 1766HFE | LT1766HGN | 1766H |
| LT1766EFE-5 | 1766EFE-5 | LT1766EGN-5 | 17665 |
| LT1766IFE-5 | 1766IFE-5 | LT1766IGN-5 | 1766I5 |

Order Options Tape and Reel: Add \#TR
Lead Free: Add \#PBF Lead Free Tape and Reel: Add \#TRPBF
Lead Free Part Marking: http://www.linear.com/leadfree/
Consult LTC Marketing for parts specified with wider operating temperature ranges.

## ELECTRICAL CHARACTERISTICS (LT1766E/LT1766I GRADE)

The $\bullet$ denotes specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$.
$V_{I N}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}=1.5 \mathrm{~V}, \overline{\mathrm{SHDN}}=1 \mathrm{~V}$, BOOST open circuit, SW open circuit, unless otherwise noted.

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |  |
| :--- | :--- | :---: | :---: | :---: | :---: | ---: |
| Reference Voltage (VREF) (LT1766) | $5.5 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq 60 \mathrm{~V}$ | 1.204 | 1.219 | 1.234 | V |  |
|  | $\mathrm{~V}_{\text {OL }}+0.2 \leq \mathrm{V}_{\mathrm{C}} \leq \mathrm{V}_{\text {OH }}-0.2$ | $\bullet$ | 1.195 |  | 1.243 | V |
| SENSE Voltage (LT1766-5) | $5.5 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq 60 \mathrm{~V}$ |  | 4.94 | 5 | 5.06 | V |
|  | $\mathrm{~V}_{0 \mathrm{LL}}+0.2 \mathrm{~V} \leq \mathrm{V}_{\mathrm{C}} \leq \mathrm{V}_{\text {OH }}-0.2 \mathrm{~V}$ | $\bullet$ | 4.90 |  | 5.10 | V |
| SENSE Pin Resistance (LT1766-5) |  | 9.5 | 13.8 | 19 | $\mathrm{k} \Omega$ |  |
| FB Input Bias Current (LT1766) |  | $\bullet$ | -0.5 | -1.5 | $\mu \mathrm{~A}$ |  |

## ELECTRICAL CHARACTGRISTICS (LT1766E/T1766G GRade)

The $\bullet$ denotes specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$.
$V_{I N}=15 V, V_{C}=1.5 \mathrm{~V}, \overline{S H D N}=1 V$, BOOST open circuit, SW open circuit, unless otherwise noted.

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Error Amp Voltage Gain | (Notes 2, 9) |  | 200 | 400 |  | V/V |
| Error Amp gm | $\mathrm{dl}\left(\mathrm{V}_{\mathrm{C}}\right)= \pm 10 \mu \mathrm{~A}$ (Note 9) | $\bullet$ | $\begin{aligned} & 1500 \\ & 1000 \end{aligned}$ | 2000 | $\begin{aligned} & 3000 \\ & 4200 \end{aligned}$ | $\mu \mathrm{Mho}$ $\mu \mathrm{Mho}$ |
| $\mathrm{V}_{\mathrm{C}}$ to Switch $\mathrm{gm}_{\mathrm{m}}$ |  |  |  | 1.7 |  | A/V |
| EA Source Current | $\mathrm{FB}=1 \mathrm{~V}$ or $\mathrm{V}_{\text {SENSE }}=4.1 \mathrm{~V}$ | $\bullet$ | 125 | 225 | 400 | $\mu \mathrm{A}$ |
| EA Sink Current | $\mathrm{FB}=1.4 \mathrm{~V}$ or $\mathrm{V}_{\text {SENSE }}=5.7 \mathrm{~V}$ | $\bullet$ | 100 | 225 | 450 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {C }}$ Switching Threshold | Duty Cycle $=0$ |  |  | 0.9 |  | V |
| $\mathrm{V}_{\text {C }}$ High Clamp | $\overline{\text { SHDN }}=1 \mathrm{~V}$ |  |  | 2.1 |  | V |
| Switch Current Limit | $\mathrm{V}_{\text {C }}$ Open, Boost $=\mathrm{V}_{\text {IN }}+5 \mathrm{~V}, \mathrm{FB}=1 \mathrm{~V}$ or $\mathrm{V}_{\text {SENSE }}=4.1 \mathrm{~V}$ | $\bullet$ | 1.5 | 2 | 3 | A |
| Switch On Resistance | $\mathrm{I}_{\text {SW }}=1.5 \mathrm{~A}$, Boost $=\mathrm{V}_{\text {IN }}+5 \mathrm{~V}$ (Note 7) | $\bullet$ |  | 0.2 | $\begin{aligned} & 0.3 \\ & 0.4 \end{aligned}$ | $\Omega$ $\Omega$ |
| Maximum Switch Duty Cycle | $\mathrm{FB}=1 \mathrm{~V}$ or $\mathrm{V}_{\text {SENSE }}=4.1 \mathrm{~V}$ | $\bullet$ | $\begin{aligned} & 93 \\ & 90 \end{aligned}$ | 96 |  | \% |
| Switch Frequency | $V_{C}$ Set to Give DC $=50 \%$ | $\bullet$ | $\begin{aligned} & 184 \\ & 172 \end{aligned}$ | $\begin{aligned} & 200 \\ & 200 \end{aligned}$ | $\begin{aligned} & 216 \\ & 228 \end{aligned}$ | $\begin{aligned} & \mathrm{kHz} \\ & \mathrm{kHz} \end{aligned}$ |
| $\mathrm{f}_{\text {SW L Line Regulation }}$ | $5.5 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq 60 \mathrm{~V}$ | $\bullet$ |  | 0.05 | 0.15 | \%/V |
| $\mathrm{f}_{\text {SW }}$ Frequency Shifting Threshold | Df $=10 \mathrm{kHz}$ |  |  | 0.8 |  | V |
| Minimum Input Voltage | (Note 3) | $\bullet$ |  | 4.6 | 5.5 | V |
| Minimum Boost Voltage | (Note 4) $\mathrm{I}_{\text {SW }} \leq 1.5 \mathrm{~A}$ | $\bullet$ |  | 1.8 | 3 | V |
| Boost Current (Note 5) | $\begin{aligned} & \text { Boost }=\mathrm{V}_{\text {IN }}+5 \mathrm{~V}, \mathrm{I}_{\text {SW }}=0.5 \mathrm{~A} \\ & \text { Boost }=\mathrm{V}_{\text {IN }}+5 \mathrm{~V}, I_{\text {SW }}=1.5 \mathrm{~A} \end{aligned}$ | $\bullet$ |  | $\begin{aligned} & 12 \\ & 45 \end{aligned}$ | $\begin{aligned} & 25 \\ & 70 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| Input Supply Current (Ivin) | (Note 6) $\mathrm{V}_{\text {BIAS }}=5 \mathrm{~V}$ |  |  | 1.4 | 2.2 | mA |
| Bias Supply Current (IBIAS) | (Note 6) $\mathrm{V}_{\text {BIAS }}=5 \mathrm{~V}$ |  |  | 2.9 | 4.2 | mA |
| Shutdown Supply Current | $\overline{S H D N}=0 \mathrm{~V}, \mathrm{~V}_{\text {IN }} \leq 60 \mathrm{~V}, \mathrm{SW}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}$ Open | $\bullet$ |  | 25 | $\begin{gathered} 75 \\ 200 \end{gathered}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| Lockout Threshold | $V_{C}$ Open | $\bullet$ | 2.3 | 2.42 | 2.53 | V |
| Shutdown Thresholds | $\begin{aligned} & \hline V_{C} \text { Open, Shutting Down } \\ & V_{C} \text { Open, Starting Up } \end{aligned}$ | $\bullet$ | $\begin{aligned} & \hline 0.15 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 0.37 \\ & 0.45 \end{aligned}$ | $\begin{aligned} & 0.6 \\ & 0.6 \end{aligned}$ | V |
| Minimum SYNC Amplitude |  | $\bullet$ |  | 1.5 | 2.2 | V |
| SYNC Frequency Range |  |  | 228 |  | 700 | kHz |
| SYNC Input Resistance |  |  |  | 20 |  | k $\Omega$ |

## (LT1766H GRADE)

The $\bullet$ denotes specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$.
$V_{I N}=15 V, V_{C}=1.5 \mathrm{~V}$, SHDN $=1 V$, BOOST open circuit, SW open circuit, unless otherwise noted.

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Reference Voltage (VEF) | $\begin{aligned} & 5.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq 60 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{OL}}+0.2 \leq \mathrm{V}_{\mathrm{C}} \leq \mathrm{V}_{\mathrm{OH}}-0.2 \end{aligned}$ | $\bullet$ | $\begin{aligned} & 1.204 \\ & 1.175 \end{aligned}$ | 1.219 | $\begin{aligned} & 1.234 \\ & 1.265 \end{aligned}$ | V |
| FB Input Bias Current |  | $\bullet$ |  | -0.5 | -1.5 | $\mu \mathrm{A}$ |
| Error Amp Voltage Gain | (Notes 2, 9) |  | 200 | 400 |  | $\mathrm{V} / \mathrm{V}$ |
| Error Amp gm | $\mathrm{dl}\left(\mathrm{V}_{\mathrm{C}}\right)= \pm 10 \mu \mathrm{~A}$ (Note 9) | $\bullet$ | $\begin{gathered} 1500 \\ 900 \\ \hline \end{gathered}$ | 2000 | $\begin{aligned} & 3000 \\ & 4200 \\ & \hline \end{aligned}$ | $\mu \mathrm{Mho}$ $\mu \mathrm{Mho}$ |
| $V_{c}$ to Switch $g_{m}$ |  |  |  | 1.7 |  | A/V |
| EA Source Current | $\mathrm{FB}=1 \mathrm{~V}$ or $\mathrm{V}_{\text {SENSE }}=4.1 \mathrm{~V}$ | - | 125 | 225 | 400 | $\mu \mathrm{A}$ |
| EA Sink Current | $\mathrm{FB}=1.4 \mathrm{~V}$ or $\mathrm{V}_{\text {SENSE }}=5.7 \mathrm{~V}$ | $\bullet$ | 100 | 225 | 450 | $\mu \mathrm{A}$ |
|  |  |  |  |  |  | 1766tb |
|  |  |  |  |  |  | 3 |

## ELECTRICAL CHARACTERISTICS (LT1766H GRade)

The $\bullet$ denotes specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$.
$\mathrm{V}_{\text {IN }}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}=1.5 \mathrm{~V}, \overline{\mathrm{SHDN}}=1 \mathrm{~V}$, BOOST open circuit, SW open circuit, unless otherwise noted.

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {C }}$ Switching Threshold | Duty Cycle = 0 |  |  | 0.9 |  | V |
| $\mathrm{V}_{\text {c }}$ High Clamp | $\overline{\text { SHDN }}=1 \mathrm{~V}$ |  |  | 2.1 |  | V |
| Switch Current Limit | $\mathrm{V}_{\text {C }}$ Open, Boost $=\mathrm{V}_{\text {IN }}+5 \mathrm{~V}, \mathrm{FB}=1 \mathrm{~V}$ or $\mathrm{V}_{\text {SENSE }}=4.1 \mathrm{~V}$ | $\bullet$ | 0.75 | 2 | 3 | A |
| Switch On Resistance | $\mathrm{I}_{\text {SW }}=0.75 \mathrm{~A}$, Boost $=\mathrm{V}_{\text {IN }}+5 \mathrm{~V}$ (Note 7) | $\bullet$ |  | 0.2 | $\begin{aligned} & 0.3 \\ & 0.8 \end{aligned}$ | ת $\Omega$ |
| Maximum Switch Duty Cycle | $\mathrm{FB}=1 \mathrm{~V}$ or $\mathrm{V}_{\text {SENSE }}=4.1 \mathrm{~V}$ | $\bullet$ | $\begin{aligned} & 93 \\ & 90 \end{aligned}$ | 96 |  | \% |
| Switch Frequency | $V_{C}$ Set to Give DC $=50 \%$ | $\bullet$ | $\begin{aligned} & 184 \\ & 135 \end{aligned}$ | $\begin{aligned} & 200 \\ & 200 \end{aligned}$ | $\begin{aligned} & 216 \\ & 228 \end{aligned}$ | kHz kHz |
| ${ }_{\text {f }}$ S Line Regulation | $5.5 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq 60 \mathrm{~V}$ | $\bullet$ |  | 0.05 | 0.15 | \%/V |
| $\mathrm{f}_{\text {Sw }}$ Frequency Shifting Threshold | $\mathrm{Df}=10 \mathrm{kHz}$ |  |  | 0.8 |  | V |
| Minimum Input Voltage | (Note 3) | $\bullet$ |  | 4.6 | 5.5 | V |
| Minimum Boost Voltage | (Note 4) $\mathrm{ISw} \leq 0.75 \mathrm{~A}$ | $\bullet$ |  | 1.8 | 3 | V |
| Boost Current (Note 5) | $\begin{aligned} & \text { Boost }=\mathrm{V}_{\text {IN }}+5 \mathrm{~V}, \mathrm{I}_{\text {SW }}=0.5 \mathrm{~A} \\ & \text { Boost }=\mathrm{V}_{\text {IN }}+5 \mathrm{~V}, \mathrm{I}_{\text {SW }}=0.75 \mathrm{~A} \end{aligned}$ | $\bullet$ |  | $\begin{aligned} & 12 \\ & 45 \end{aligned}$ | $\begin{aligned} & 40 \\ & 100 \end{aligned}$ | mA mA |
| Input Supply Current ( $\mathrm{l}_{\mathrm{VIN}}$ ) | (Note 6) $\mathrm{V}_{\text {BIAS }}=5 \mathrm{~V}$ |  |  | 1.4 | 2.2 | mA |
| Bias Supply Current (IBIAS) | (Note 6) $\mathrm{V}_{\text {BIAS }}=5 \mathrm{~V}$ |  |  | 2.9 | 4.2 | mA |
| Shutdown Supply Current | $\overline{\mathrm{SHDN}}=0 \mathrm{~V}, \mathrm{~V}_{\text {IN }} \leq 60 \mathrm{~V}, \mathrm{SW}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}$ Open | $\bullet$ |  | 25 | $\begin{aligned} & 120 \\ & 500 \\ & \hline \end{aligned}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| Lockout Threshold | $V_{C}$ Open | $\bullet$ | 2.3 | 2.42 | 2.68 | V |
| Shutdown Thresholds | $V_{C}$ Open, Shutting Down <br> $V_{C}$ Open, Starting Up | $\bullet$ | $\begin{aligned} & \hline 0.15 \\ & 0.25 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline 0.37 \\ & 0.45 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.9 \\ & 0.9 \\ & \hline \end{aligned}$ | V |
| Minimum SYNC Amplitude |  | $\bullet$ |  | 1.5 | 2.2 | V |
| SYNC Frequency Range |  |  | 228 |  | 700 | kHz |
| SYNC Input Resistance |  |  |  | 20 |  | $\mathrm{k} \Omega$ |

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.
Note 2: Gain is measured with a $V_{C}$ swing equal to 200 mV above the low clamp level to 200 mV below the upper clamp level.
Note 3: Minimum input voltage is not measured directly, but is guaranteed by other tests. It is defined as the voltage where internal bias lines are still regulated so that the reference voltage and oscillator remain constant. Actual minimum input voltage to maintain a regulated output will depend upon output voltage and load current. See Applications Information.
Note 4: This is the minimum voltage across the boost capacitor needed to guarantee full saturation of the internal power switch.
Note 5: Boost current is the current flowing into the BOOST pin with the pin held 5 V above input voltage. It flows only during switch on time.
Note 6: Input supply current is the quiescent current drawn by the input pin when the BIAS pin is held at 5 V with switching disabled. Bias supply current is the current drawn by the BIAS pin when the BIAS pin is held at 5 V . Total input referred supply current is calculated by summing input supply current (ly/is) with a fraction of bias supply current ( (IBIAS):
$I_{\text {TOTAL }}=I_{\text {VIN }}+\left(I_{\text {BIAS }}\right)\left(V_{\text {OUT }} N_{\text {IN }}\right)$
With $\mathrm{V}_{\text {IN }}=15 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{VIN}}=1.4 \mathrm{~mA}, \mathrm{I}_{\text {BIAS }}=2.9 \mathrm{~mA}, \mathrm{I}_{\text {TOTAL }}=2.4 \mathrm{~mA}$.
Note 7: Switch on resistance is calculated by dividing $\mathrm{V}_{\mathrm{IN}}$ to SW voltage by the
forced current. See Typical Performance Characteristics for the graph of switch voltage at other currents.
Note 8: The LT1766EGN, LT1766EGN-5, LT1766EFE and LT1766EFE-5 are guaranteed to meet performance specifications from $0^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ junction temperature. Specifications over the $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ operating junction temperature range are assured by design, characterization and correlation with statistical process controls. The LT1766IGN, LT1766IGN-5, LT1766IFE and LT17661FE-5 are guaranteed over the full
$-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ operating junction temperature range. The LT1766HGN and LT1766HFE are guaranteed over the full $-40^{\circ} \mathrm{C}$ to $140^{\circ} \mathrm{C}$ operating junction temperature range.
Note 9: Transconductance and voltage gain refer to the internal amplifier exclusive of the voltage divider. To calculate gain and transconductance, refer to the SENSE pin on fixed voltage parts. Divide the values shown by the ratio $\mathrm{V}_{\text {OUT }} / 1.219$.
Note 10: This IC includes overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed $140^{\circ} \mathrm{C}$ when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature may impair device reliability.
Note 11: High junction temperatures degrade operating lifetimes. Operating lifetime at junction temperatures between $125^{\circ} \mathrm{C}$ and $140^{\circ} \mathrm{C}$ is derated to 1000 hours.

## TYPICAL PGRFORMANCG CHARACTERISTICS



## TYPICAL PGRFORMANCG CHARACTGRISTICS



## PIn functions

GND (Pins 1, 8, 9, 16, 17): The GND pin connections act as the reference for the regulated output, so load regulation will suffer if the "ground" end of the load is not at the same voltage as the GND pins of the IC. This condition will occur when load current or other currents flow through metal paths between the GND pins and the load ground. Keep the paths between the GND pins and the load ground short and use a ground plane when possible. The GND pin also acts as a heat sink and should be soldered to a large copper plane to reduce thermal resistance. For the FE package, the exposed pad should be soldered to the
copper ground plane underneath the device. (See Applications Information-Layout Considerations.)
SW (Pin 2): The switch pin is the emitter of the on-chip power NPN switch. This pin is driven up to the input pin voltage during switch on time. Inductor current drives the switch pin negative during switch off time. Negative voltage is clamped with the external catch diode. Maximum negative switch voltage allowed is -0.8 V .
NC (Pins 3, 5, 7, 13): No Connection.

## PIn fUnCTIOns

$V_{\text {IN }}$ (Pin 4): This is the collector of the on-chip power NPN switch. $\mathrm{V}_{\text {IN }}$ powers the internal control circuitry when a voltage on the BIAS pin is not present. High dI/dt edges occur on this pin during switch turn on and off. Keep the path short from the $\mathrm{V}_{\text {IN }}$ pin through the input bypass capacitor, through the catch diode back to SW. All trace inductance on this path will create a voltage spike at switch off, adding to the $\mathrm{V}_{\text {CE }}$ voltage across the internal NPN.

BOOST (Pin 6): The BOOST pin is used to provide a drive voltage, higher than the input voltage, to the internal bipolar NPN power switch. Without this added voltage, the typical switch voltage loss would be about 1.5 V . The additional BOOST voltage allows the switch to saturate and voltage loss approximates that of a $0.2 \Omega$ FET structure, but with much smaller die area.

BIAS (Pin 10): The BIAS pin is used to improve efficiency when operating at higher input voltages and light load current. Connecting this pin to the regulated output voltage forces most of the internal circuitry to draw its operating current from the output voltage rather than the input supply. This architecture increases efficiency especially when the input voltage is much higher than the output. Minimum output voltage setting for this mode of operation is 3 V .
$V_{C}$ (Pin 11) The $V_{C}$ pin is the output of the error amplifier and the input of the peak switch current comparator. It is normally used for frequency compensation, but can also serve as a current clamp or control loop override. $\mathrm{V}_{\mathrm{C}}$ sits at about 0.9 V for light loads and 2.1 V at maximum load. It can be driven to ground to shut off the regulator, but if driven high, current must be limited to 4 mA .

FB/SENSE (Pin 12): The feedback pin is used to set the output voltage using an external voltage divider that generates 1.22 V at the pin for the desired output voltage. The 5 V fixed output voltage parts have the divider included on the chip and the FB pin is used as a SENSE pin, connected directly to the 5 V output. Three additional functions are performed by the FB pin. When the pin voltage drops below 0.6 V , switch current limit is reduced and the external SYNC function is disabled. Below 0.8 V , switching frequency is also reduced. See Feedback Pin Functions in Applications Information for details.

SYNC (Pin 14): The SYNC pin is used to synchronize the internal oscillator to an external signal. It is directly logic compatible and can be driven with any signal between $10 \%$ and $90 \%$ duty cycle. The synchronizing range is equal to initial operating frequency up to 700 kHz . See Synchronizing in Applications Information for details.
$\overline{\text { SHDN }}$ (Pin 15): The $\overline{\text { SHDN }}$ pin is used to turn off the regulator and to reduce input drain current to a few microamperes. This pin has two thresholds: one at 2.38 V to disable switching and a second at 0.4 V to force complete micropower shutdown. The 2.38 V threshold functions as an accurate undervoltage lockout (UVLO); sometimes used to prevent the regulator from delivering power until the input voltage has reached a predetermined level.

If the $\overline{\text { SHDN }}$ pin functions are not required, the pin can either be left open (to allow an internal bias current to lift the pin to a default high state) or be forced high to a level not to exceed 6V.

## BLOCK DIAGRAM

The LT1766 is a constant frequency, current mode buck converter. This means that there is an internal clock and two feedback loops that control the duty cycle of the power switch. In addition to the normal error amplifier, there is a current sense amplifier that monitors switch current on a cycle-by-cycle basis. A switch cycle starts with an oscillator pulse which sets the $\mathrm{R}_{\mathrm{S}}$ flip-flop to turn the switch on. When switch current reaches a level set by the inverting
input of the comparator, the flip-flop is reset and the switch turns off. Output voltage control is obtained by using the output of the error amplifier to set the switch current trip point. This technique means that the error amplifier commands current to be delivered to the output rather than voltage. A voltage fed system will have low phase shift up to the resonant frequency of the inductor and output capacitor, then an abrupt $180^{\circ}$ shift will occur.

## LT1766/LT1766-5

## BLOCK DIAGRAM

The current fed system will have $90^{\circ}$ phase shift at a much lower frequency, but will not have the additional $90^{\circ}$ shift until well beyond the LC resonant frequency. This makes it much easier to frequency compensate the feedback loop and also gives much quicker transient response.
Most of the circuitry of the LT1766 operates from an internal 2.9 V bias line. The bias regulator normally draws power from the regulator input pin, but if the BIAS pin is connected to an external voltage higher than 3 V , bias power will be drawn from the external source (typically the
regulated output voltage). This will improve efficiency if the BIAS pin voltage is lower than regulator input voltage. High switch efficiency is attained by using the BOOST pin to provide a voltage to the switch driver which is higher than the input voltage, allowing switch to be saturated. This boosted voltage is generated with an external capacitor and diode. Two comparators are connected to the shutdown pin. One has a 2.38 V threshold for undervoltage lockout and the second has a 0.4 V threshold for complete shutdown.


Figure 1. LT1766 Block Diagram

## APPLICATIONS INFORMATION

## FEEDBACK PIN FUNCTIONS

The feedback (FB) pin on the LT1766 is used to set output voltage and provide several overload protection features. The first part of this section deals with selecting resistors to set output voltage and the remaining part talks about foldback frequency and current limiting created by the FB pin. Please read both parts before committing to a final design. The 5V fixed output voltage part (LT1766-5) has internal divider resistors and the FB pin is renamed SENSE, connected directly to the output.
The suggested value for the output divider resistor (see Figure 2) from FB to ground (R2) is $5 k$ or less, and a formula for R1 is shown below. The output voltage error caused by ignoring the input bias current on the FB pin is less than $0.25 \%$ with R2 $=5 k$. A table of standard $1 \%$ values is shown in Table 1 for common output voltages. Please read the following if divider resistors are increased above the suggested values.

$$
\mathrm{R} 1=\frac{\mathrm{R} 2\left(\mathrm{~V}_{\text {OUT }}-1.22\right)}{1.22}
$$

Table 1

| OUTPUT <br> VOLTAGE <br> (V) | R2 <br> $(\mathbf{k} \Omega)$ | R1 <br> (NEAREST 1\%) <br> $(\mathbf{k} \Omega)$ | \% ERROR AT OUTPUT <br> DUE TO DISCREET 1\% <br> RESISTOR STEPS |
| :---: | :---: | :---: | :---: |
| 3 | 4.99 | 7.32 | +0.32 |
| 3.3 | 4.99 | 8.45 | -0.43 |
| 5 | 4.99 | 15.4 | -0.30 |
| 6 | 4.75 | 18.7 | +0.38 |
| 8 | 4.47 | 24.9 | +0.20 |
| 10 | 4.32 | 30.9 | -0.54 |
| 12 | 4.12 | 36.5 | +0.24 |
| 15 | 4.12 | 46.4 | -0.27 |

## More Than Just Voltage Feedback

The feedback pin is used for more than just output voltage sensing. It also reduces switching frequency and current limit when output voltage is very low (see the Frequency Foldback graph in Typical Performance Characteristics). This is done to control power dissipation in both the IC and in the external diode and inductor during short-circuit conditions. A shorted output requires the
switching regulator to operate at very low duty cycles, and the average current through the diode and inductor is equal to the short-circuit current limit of the switch (typically 2A for the LT1766, folding back to less than 1A). Minimum switch on time limitations would prevent the switcher from attaining a sufficiently low duty cycle if switching frequency were maintained at 200 kHz , so frequency is reduced by about $5: 1$ when the feedback pin voltage drops below 0.8 V (see Frequency Foldbackgraph). This does not affect operation with normal load conditions; one simply sees a gear shift in switching frequency during start-up as the output voltage rises.

In addition to lower switching frequency, the LT1766 also operates at lower switch current limit when the feedback pin voltage drops below 0.6V. Q2 in Figure 2 performs this function by clamping the $\mathrm{V}_{\mathrm{C}}$ pin to a voltage less than its normal 2.1V upper clamp level. This foldback current limit greatly reduces power dissipation in the IC, diode and inductor during short-circuit conditions. External synchronization is also disabled to prevent interference with foldback operation. Again, it is nearly transparent to the user under normal load conditions. The only loads that may be affected are current source loads which maintain full load current with output voltage less than 50\% of final value. In these rare situations the feedback pin can be clamped above 0.6 V with an external diode to defeat foldback currentlimit. Caution: clamping the feedback pin means that frequency shifting will also be defeated, so a combination of high inputvoltage and dead shorted output may cause the LT1766 to lose control of current limit.

The internal circuitry which forces reduced switching frequency also causes current to flow out of the feedback pin when output voltage is low. The equivalent circuitry is shown in Figure 2. Q1 is completely off during normal operation. If the FB pin falls below $0.8 \mathrm{~V}, \mathrm{Q} 1$ begins to conduct current and reduces frequency at the rate of approximately $1.4 \mathrm{kHz} / \mu \mathrm{A}$. To ensure adequate frequency foldback (under worst-case short-circuit conditions), the external divider Thevinin resistance must be low enough to pull $115 \mu \mathrm{~A}$ out of the FB pin with 0.44 V on the pin ( $\mathrm{R}_{\text {DIV }}$ $\leq 3.8 \mathrm{k})$. The net result is that reductions in frequency and current limit are affected by output voltage divider impedance. Although divider impedance is not critical, caution

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Figure 2. Frequency and Current Limit Foldback
should be used if resistors are increased beyond the suggested values and short-circuit conditions occur with high input voltage. High frequency pickup will increase and the protection accorded by frequency and current foldback will decrease.

## CHOOSING THE INDUCTOR

For most applications, the output inductor will fall into the range of $15 \mu \mathrm{H}$ to $100 \mu \mathrm{H}$. Lower values are chosen to reduce physical size of the inductor. Higher values allow more output current because they reduce peak current seen by the LT1766 switch, which has a 1.5A limit. Higher values also reduce output ripple voltage.
When choosing an inductor you will need to consider output ripple voltage, maximum load current, peak inductor current and fault current in the inductor. In addition, other factors such as core and copper losses, allowable component height, EMI, saturation and cost should also be considered. The following procedure is suggested as a way of handling these somewhat complicated and conflicting requirements.

## Output Ripple Voltage

Figure 3 shows a typical output ripple voltage waveform for the LT1766. Ripple voltage is determined by ripple current (llp-p) through the inductor and the high frequency impedance of the output capacitor. The following equations will help in choosing the required inductor
value to achieve a desirable output ripple voltage level. If output ripple voltage is of less importance, the subsequent suggestions in Peak Inductor and Fault Current and EMI will additionally help in the selection of the inductor value.

Peak-to-peak output ripple voltage is the sum of a triwave (created by peak-to-peak ripple current (lLP-p) times ESR) and a square wave (created by parasitic inductance (ESL) and ripple current slew rate). Capacitive reactance is assumed to be small compared to ESR or ESL.

$$
V_{\text {RIPPLE }}=\left(l_{\text {LP-P }}\right)(\mathrm{ESR})+(\mathrm{ESL}) \frac{\mathrm{dl}}{\mathrm{dt}}
$$

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where:
ESR = equivalent series resistance of the output capacitor

ESL = equivalent series inductance of the output capacitor
$\mathrm{dl} / \mathrm{dt}=$ slew rate of inductor ripple current $=\mathrm{V}_{\text {IN }} / \mathrm{L}$
Peak-to-peak ripple current (llp-p) through the inductor and into the output capacitor is typically chosen to be between $20 \%$ and $40 \%$ of the maximum load current. It is approximated by:

$$
L_{\text {LP-P }}=\frac{\left(V_{\text {OUT }}\right)\left(V_{\text {IN }}-V_{\text {OUT }}\right)}{\left(V_{\text {IN }}\right)(f)(\mathrm{f})(\mathrm{L})}
$$

Example: with $\mathrm{V}_{\text {IN }}=40 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}, \mathrm{~L}=47 \mu \mathrm{H}, \mathrm{ESR}=0.1 \Omega$ and $\mathrm{ESL}=10 \mathrm{nH}$, output ripple voltage can be approximated as follows:

$$
\begin{aligned}
& \mathrm{I}_{\mathrm{P}-\mathrm{P}}=\frac{(5)(40-5)}{(40)\left(47 \cdot 10^{-6}\right)\left(200 \cdot 10^{3}\right)}=0.465 \mathrm{~A} \\
& \frac{\mathrm{dl}}{\mathrm{dt}}=\frac{40}{47 \cdot 10^{-6}}=10^{6} \cdot 0.85 \\
& V_{\text {RIPPLE }}=(0.465 \mathrm{~A})(0.1)+\left(10 \cdot 10^{-9}\right)\left(10^{6}\right)(0.85) \\
& =0.0465+0.0085=55 \mathrm{mV} V_{P-P}
\end{aligned}
$$

To reduce output ripple voltage further requires an increase in the inductor value or a reduction in the capacitor ESR. The latter can effect loop stability since the ESR forms a useful zero in the overall loop response. Typically the inductor value is adjusted with the trade-off being a physically larger inductor with the possibility of increased component height and cost. Choosing a smaller inductor with lighter loads may result in discontinuous operation but the LT1766 is designed to work well in both continuous or discontinuous mode.

## Peak Inductor Current and Fault Current

To ensure that the inductor will not saturate, the peak inductor current should be calculated knowing the maximum load current. An appropriate inductor should then be chosen. In addition, a decision should be made whether
or not the inductor must withstand continuous fault conditions.
If maximum load current is 0.5 A , for instance, a 0.5 A inductor may not survive a continuous 2A overload condition. Dead shorts will actually be more gentle on the inductor because the LT1766 has frequency and current limit foldback.
Peak switch and inductor current can be significantly higher than output current, especially with smaller inductors and lighter loads, so don't omit this step. Powdered iron cores are forgiving because they saturate softly, whereas ferrite cores saturate abruptly. Other core
Table 2

| VENDOR/ <br> PART NO. | VALUE <br> $(\mu \mathrm{H})$ | IDC <br> $($ Amps $)$ | DCR <br> $($ Ohms $)$ | HEIGHT <br> $(\mathrm{mm})$ |
| :--- | :---: | :---: | :---: | :---: |
| Coiltronics |  |  |  |  |
| CTX15-1P | 15 | 1.4 | 0.087 | 4.2 |
| CTX15-1 | 15 | 1.1 | 0.08 | 4.2 |
| CTX33-2P | 33 | 1.3 | 0.126 | 6 |
| CTX33-2 | 33 | 1.4 | 0.106 | 6 |
| UP2-330 | 33 | 2.4 | 0.099 | 5.9 |
| UP2-470 | 47 | 1.9 | 0.146 | 5.9 |
| UP2-680 | 68 | 1.7 | 0.19 | 5.9 |
| UP2-101 | 100 | 1.4 | 0.277 | 5.9 |


| Sumida |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: |
| CDRH6D28-150M | 15 | 1.4 | 0.076 | 3 |
| CDRH6D38-150M | 15 | 1.6 | 0.062 | 4 |
| CDRH6D28-330M | 33 | 0.97 | 0.122 | 3 |
| CDRH104R-330M | 33 | 2.1 | 0.069 | 3.8 |
| CDRH125-330M | 33 | 2.1 | 0.044 | 6 |
| CDRH104R-470M | 47 | 2.1 | 0.095 | 3.8 |
| CDRH125-470M | 47 | 1.8 | 0.058 | 6 |
| CDRH6D38-680M | 68 | 0.75 | 0.173 | 4 |
| CDRH104R-680M | 68 | 1.5 | 0.158 | 3.8 |
| CDRH125-680M | 68 | 1.5 | 0.093 | 6 |
| CDRH104R-101M | 100 | 1.35 | 0.225 | 3.8 |
| CDRH125-101M | 100 | 1.3 | 0.120 | 6 |

Coilcraft

| DT3316P-153 | 15 | 1.8 | 0.06 | 5 |
| :--- | :---: | :---: | :---: | :---: |
| DT3316P-333 | 33 | 1.3 | 0.09 | 5 |
| DT3316P-473 | 47 | 1 | 0.11 | 5 |

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materials fall somewhere in between. The following formula assumes continuous mode of operation, but errs only slightly on the high side for discontinuous mode, so it can be used for all conditions.

$$
I_{\text {PEAK }}=I_{\text {OUT }}+\frac{\left(\left(_{\text {LPP-P }}\right.\right.}{2}=I_{\text {OUT }}+\frac{\left(V_{\text {OUT }}\right)\left(V_{\text {IN }}-V_{\text {OUT }}\right)}{(2)\left(V_{\text {IN }}\right)(f)(L)}
$$

## EMI

Decide if the design can tolerate an "open" core geometry like a rod or barrel, which have high magnetic field radiation, or whether it needs a closed core like a toroid to prevent EMI problems. This is a tough decision because the rods or barrels are temptingly cheap and small and there are no helpful guidelines to calculate when the magnetic field radiation will be a problem.

## Additional Considerations

After making an initial choice, consider additional factors such as core losses and second sourcing, etc. Use the experts in Linear Technology's Applications department if you feel uncertain about the final choice. They have experience with a wide range of inductor types and can tell you about the latest developments in low profile, surface mounting, etc.

## Maximum Output Load Current

Maximum load current for a buck converter is limited by the maximum switch current rating ( $\mathrm{I}_{\mathrm{P}}$ ). The current rating for the LT1766 is 1.5A. Unlike most current mode converters, the LT1766 maximum switch current limit does not fall off at high duty cycles. Most current mode converters suffer a drop off of peak switch current for duty cycles above $50 \%$. This is due to the effects of slope compensation required to prevent subharmonic oscillations in current mode converters. (For detailed analysis, see Application Note 19.)
The LT1766 is able to maintain peak switch current limit over the full duty cycle range by using patented circuitry* to cancel the effects of slope compensation on peak switch current without affecting the frequency compensation it provides.
*Patent \# 6, 498, 466

Maximum load current would be equal to maximum switch current for an infinitely large inductor, but with finite inductor size, maximum load current is reduced by one-half peak-to-peak inductor current (lLP-P). The following formula assumes continuous mode operation, implying that the term on the right is less than one-half of $I_{p}$.
$I_{\text {OUT(MAX) }}=$
Continuous Mode

$$
I_{P}-\frac{I_{L P-P}}{2}=I_{P}-\frac{\left(V_{\text {OUT }}+V_{F}\right)\left(V_{\text {IN }}-V_{\text {OUT }}-V_{F}\right)}{2(L)(f)\left(V_{\text {IN }}\right)}
$$

For $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=8 \mathrm{~V}, \mathrm{~V}_{\mathrm{F}(\mathrm{D} 1)}=0.63 \mathrm{~V}, \mathrm{f}=200 \mathrm{kHz}$ and $L=20 \mu \mathrm{H}$ :

$$
\begin{aligned}
\mathrm{I}_{\mathrm{OUT}(\mathrm{MAX})} & =1.5-\frac{(5+0.63)(8-5-0.63)}{2\left(20 \cdot 10^{-6}\right)\left(200 \cdot 10^{3}\right)(8)} \\
& =1.5-0.21=1.29 \mathrm{~A}
\end{aligned}
$$

Note that there is less load current available at the higher input voltage because inductor ripple current increases. At $\mathrm{V}_{\text {IN }}=15 \mathrm{~V}$, duty cycle is $33 \%$ and for the same set of conditions:

$$
\begin{aligned}
\mathrm{I}_{\text {OUT(MAX) }} & =1.5-\frac{(5+0.63)(15-5-0.63)}{2\left(20 \cdot 10^{-6}\right)\left(200 \cdot 10^{3}\right)(15)} \\
& =1.5-0.44=1.06 \mathrm{~A}
\end{aligned}
$$

To calculate actual peak switch current with a given set of conditions, use:

$$
\begin{aligned}
I_{\text {SW(PEAK })} & =I_{\text {OUT }}+\frac{I_{\text {LP-P }}}{2} \\
& =I_{\text {OUT }}+\frac{\left.\mathrm{N}_{\text {OUT }}+V_{F}\right)\left(V_{\text {IN }}-V_{\text {OUT }}-V_{F}\right)}{2(L)(f)\left(V_{\text {IN }}\right)}
\end{aligned}
$$

## Reduced Inductor Value and Discontinuous Mode

If the smallest inductor value is of most importance to a converter design, in order to reduce inductor size/cost, discontinuous mode may yield the smallest inductor solution. The maximum output load current in discontinuous mode, however, must be calculated and is defined later in this section.

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its normal value. Below this point the oscillator frequency decreases roughly linearly down to a limit of about 40kHz. This lower oscillator frequency during short-circuit conditions can then maintain control with the effective minimum on time.

It is recommended that for $\left[\mathrm{V}_{\mathrm{IN}} /\left(\mathrm{V}_{\text {OUT }}+\mathrm{V}_{\mathrm{F}}\right)\right]$ ratios $>10$, a soft-start circuit should be used to control the output capacitor charge rate during start-up or during recovery from an output short circuit, thereby adding additional control over peak inductor current. See Buck Converter with Adjustable Soft-Start later in this data sheet.

## OUTPUT CAPACITOR

The output capacitor is normally chosen by its effective series resistance (ESR), because this is what determines output ripple voltage. To get low ESR takes volume, so physically smaller capacitors have high ESR. The ESR range for typical LT1766 applications is $0.05 \Omega$ to $0.2 \Omega$. A typical output capacitor is an AVX type TPS, $100 \mu \mathrm{~F}$ at 10 V , with a guaranteed ESR less than $0.1 \Omega$. This is a " $D$ " size surface mount solid tantalum capacitor. TPS capacitors are specially constructed and tested for low ESR, so they give the lowest ESR for a given volume. The value in microfarads is not particularly critical, and values from $22 \mu \mathrm{~F}$ to greater than $500 \mu \mathrm{~F}$ work well, but you cannot cheat mother nature on ESR. If you find a tiny $22 \mu \mathrm{~F}$ solid tantalum capacitor, it will have high ESR, and output ripple voltage will be terrible. Table 2 shows some typical solid tantalum surface mount capacitors.
Table 3. Surface Mount Solid Tantalum Capacitor ESR and Ripple Current

| E Case Size | ESR (Max, $\Omega$ ) | Ripple Current (A) |
| :--- | :---: | :---: |
| AVX TPS, Sprague 593D | 0.1 to 0.3 | 0.7 to 1.1 |
| D Case Size |  |  |
| AVX TPS, Sprague 593D | 0.1 to 0.3 | 0.7 to 1.1 |
| C Case Size |  |  |
| AVX TPS | 0.2 (typ) | 0.5 (typ) |

Many engineers have heard that solid tantalum capacitors are prone to failure if they undergo high surge currents. This is historically true, and type TPS capacitors are specially tested for surge capability, but surge ruggedness is not a critical issue with the output capacitor. Solid
tantalum capacitors fail during very high turn-on surges, which do not occur at the output of regulators. High discharge surges, such as when the regulator output is dead shorted, do not harm the capacitors.

Unlike the input capacitor, RMS ripple current in the output capacitor is normally low enough that ripple current rating is not an issue. The current waveform is triangular with a typical value of $125 \mathrm{~mA}_{\text {RMS }}$. The formula to calculate this is:

Output capacitor ripple current (RMS):

$$
\mathrm{I}_{\text {RIPPLE(RMS })}=\frac{0.29\left(\mathrm{~V}_{\text {OUT }}\right)\left(\mathrm{V}_{\text {IN }}-\mathrm{V}_{\text {OUT }}\right)}{(\mathrm{L})(\mathrm{f})\left(\mathrm{V}_{\text {IN }}\right)}
$$

## Ceramic Capacitors

Higher value, lower cost ceramic capacitors are now becoming available. They are generally chosen for their good high frequency operation, small size and very low ESR (effective series resistance). Their low ESR reduces output ripple voltage but also removes a useful zero in the loop frequency response, common to tantalum capacitors. To compensate for this, a resistor $R_{C}$ can be placed in series with the $\mathrm{V}_{\mathrm{C}}$ compensation capacitor $\mathrm{C}_{\mathrm{C}}$. Care must be taken however, since this resistor sets the high frequency gain of the error amplifier, including the gain at the switching frequency. If the gain of the error amplifier is high enough at the switching frequency, output ripple voltage (although smaller for a ceramic output capacitor) may still affect the proper operation of the regulator. A filter capacitor $\mathrm{C}_{\mathrm{F}}$ in parallel with the $\mathrm{R}_{C} / \mathrm{C}_{\mathcal{C}}$ network is suggested to control possible ripple at the $\mathrm{V}_{\mathrm{C}}$ pin. An "All Ceramic" solution is possible for the LT1766 by choosing the correct compensation components for the given application.

Example: For $\mathrm{V}_{\text {IN }}=8 \mathrm{~V}$ to $40 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=3.3 \mathrm{~V}$ at 1 A , the LT1766 can be stabilized, provide good transient response and maintain very low output ripple voltage using the following component values: (refer to the first page of this data sheet for component references) $\mathrm{C} 3=2.2 \mu \mathrm{~F}$, $R_{C}=4.7 \mathrm{k}, \mathrm{C}_{\mathrm{C}}=15 \mathrm{nF}, \mathrm{C}_{\mathrm{F}}=220 \mathrm{pF}$ and $\mathrm{C} 1=47 \mu \mathrm{~F}$. See Application Note 19 for further detail on techniques for proper loop compensation.

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## INPUT CAPACITOR

Step-down regulators draw current from the input supply in pulses. The rise and fall times of these pulses are very fast. The input capacitor is required to reduce the voltage ripple this causes at the input of LT1766 and force the switching current into a tight local loop, thereby minimizing EMI. The RMS ripple current can be calculated from:

$$
I_{\text {RIPPLE }(R M S)}=I_{\text {OUT }} \sqrt{V_{\text {OUT }}\left(V_{I N}-V_{\text {OUT }}\right) / V_{\text {IN }}{ }^{2}}
$$

Ceramic capacitors are ideal for input bypassing. At200kHz switching frequency, the energy storage requirement of the input capacitor suggests that values in the range of $2.2 \mu \mathrm{~F}$ to $20 \mu \mathrm{~F}$ are suitable for most applications. If operation is required close to the minimum input required by the output of the LT1766, a larger value may be required. This is to prevent excessive ripple causing dips below the minimum operating voltage resulting in erratic operation.
Depending on how the LT1766 circuit is powered up you may need to check for input voltage transients.

The input voltage transients may be caused by input voltage steps or by connecting the LT1766 converter to an already powered up source such as a wall adapter. The sudden application of input voltage will cause a large surge of current in the input leads that will store energy in the parasitic inductance of the leads. This energy will cause the input voltage to swing above the DC level of input power source and it may exceed the maximum voltage rating of input capacitor and LT1766.

The easiest way to suppress input voltage transients is to add a small aluminum electrolytic capacitor in parallel with the low ESR input capacitor. The selected capacitor needs to have the right amount of ESR in order to critically dampen the resonant circuit formed by the input lead inductance and the input capacitor. The typical values of ESR will fall in the range of $0.5 \Omega$ to $2 \Omega$ and capacitance will fall in the range of $5 \mu \mathrm{~F}$ to $50 \mu \mathrm{~F}$.
If tantalum capacitors are used, values in the $22 \mu \mathrm{~F}$ to $470 \mu \mathrm{~F}$ range are generally needed to minimize ESR and meet ripple current and surge ratings. Care should be taken to ensure the ripple and surge ratings are not exceeded. The AVX TPS and Kemet T495 series are surge
rated. AVX recommends derating capacitor operating voltage by $2: 1$ for high surge applications.

## CATCH DIODE

Highest efficiency operation requires the use of a Schottky type diode. DC switching losses are minimized due to its low forward voltage drop, and AC behavior is benign due to its lack of a significant reverse recovery time. Schottky diodes are generally available with reverse voltage ratings of up to 60 V and even 100 V , and are price competitive with other types.
The use of so-called "ultrafast" recovery diodes is generally not recommended. When operating in continuous mode, the reverse recovery time exhibited by "ultrafast" diodes will result in a slingshot type effect. The power internal switch will ramp up $\mathrm{V}_{\text {IN }}$ current into the diode in an attempt to get it to recover. Then, when the diode has finally turned off, some tens of nanoseconds later, the $\mathrm{V}_{\text {SW }}$ node voltage ramps up at an extremely high dV/dt, perhaps 5 to even 10V/ns ! With real world lead inductances, the $\mathrm{V}_{\text {SW }}$ node can easily overshoot the $\mathrm{V}_{\text {IN }}$ rail. This can result in poor RFI behavior and if the overshoot is severe enough, damage the IC itself.

The suggested catch diode (D1) is an International Rectifier 10MQ060N Schottky. It is rated at 1.5A average forward current and 60V reverse voltage. Typical forward voltage is 0.63 V at 1 A . The diode conducts current only during switch off time. Peak reverse voltage is equal to regulator input voltage. Average forward current in normal operation can be calculated from:

$$
I_{D(A V G)}=\frac{I_{\text {OUT }}\left(V_{\text {IN }}-V_{\text {OUT }}\right)}{V_{\text {IN }}}
$$

This formula will not yield values higher than 1.5 A with maximum load current of 1.5 A . The only reason to consider a larger diode is the worst-case condition of a high input voltage and shorted output. With a shorted condition, diode current will increase to a typical value of 2 A , determined by peak switch current limit. This is safe for short periods of time, but it would be prudent to check with the diode manufacturer if continuous operation under these conditions must be tolerated.

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## BOOST PIN

For most applications, the boost components are a $0.33 \mu \mathrm{~F}$ capacitor and a 1 N 4148 W diode. The anode is typically connected to the regulated output voltage to generate a voltage approximately $\mathrm{V}_{\text {OUT }}$ above $\mathrm{V}_{\text {IN }}$ to drive the output stage. However, the output stage discharges the boost capacitor during the on time of the switch. The output driver requires at least 3 V of headroom throughout this period to keep the switch fully saturated. If the output voltage is less than 3.3 V , it is recommended that an alternate boost supply is used. The boost diode can be connected to the input, although, care must be taken to prevent the $2 \times V_{\text {IN }}$ boost voltage from exceeding the BOOST pin absolute maximum rating. The additional voltage across the switch driver also increases power loss, reducing efficiency. If available, and independent supply can be used with a local bypass capacitor.
A $0.33 \mu \mathrm{~F}$ boost capacitor is recommended for most applications. Almost any type of film or ceramic capacitor is suitable, but the ESR should be $<1 \Omega$ to ensure it can be fully recharged during the off time of the switch. The capacitor value is derived from worst-case conditions of 4700 ns on time, 42 mA boost current and 0.7 V discharge ripple. The boost capacitor value could be reduced under less demanding conditions, but this will not improve circuit operation or efficiency. Under low input voltage and low load conditions, a higher value capacitor will reduce discharge ripple and improve start-up operation.

## SHUTDOWN FUNCTION AND UNDERVOLTAGE LOCKOUT

Figure 4 shows how to add undervoltage lockout (UVLO) to the LT1766. Typically, UVLO is used in situations where the input supply is current limited, or has a relatively high source resistance. A switching regulator draws constant power from the source, so source current increases as source voltage drops. This looks like a negative resistance load to the source and can cause the source to current limit or latch low under low source voltage conditions. UVLO prevents the regulator from operating at source voltages where these problems might occur.

Threshold voltage for lockout is about 2.38V. A $5.5 \mu \mathrm{~A}$ bias current flows out of the pin at this threshold. The internally generated current is used to force a default high state on the shutdown pin if the pin is left open. When low shutdown current is not an issue, the error due to this current can be minimized by making $R_{\text {L0 }} 10 \mathrm{k}$ or less. If shutdown current is an issue, $\mathrm{R}_{\text {LO }}$ can be raised to 100k, but the error due to initial bias current and changes with temperature should be considered.
$R_{\text {LO }}=10 k$ to 100 k (25k suggested)
$R_{H I}=\frac{R_{\mathrm{LO}}\left(\mathrm{V}_{\text {IN }}-2.38 \mathrm{~V}\right)}{2.38 \mathrm{~V}-\mathrm{R}_{\mathrm{LO}}(5.5 \mu \mathrm{~A})}$
$\mathrm{V}_{\mathrm{IN}}=$ Minimum input voltage


Figure 4. Undervoltage Lockout

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Keep the connections from the resistors to the shutdown pin short and make sure that interplane or surface capacitance to the switching nodes are minimized. If high resistor values are used, the shutdown pin should be bypassed with a 1000 pF capacitor to prevent coupling problems from the switch node. If hysteresis is desired in the undervoltage lockout point, a resistor $\mathrm{R}_{\mathrm{FB}}$ can be added to the output node. Resistor values can be calculated from:

$$
\begin{aligned}
& R_{H I}=\frac{R_{\text {LO }}\left[V_{\text {IN }}-2.38\left(\Delta V / V_{\text {OUT }}+1\right)+\Delta V\right]}{2.38-R_{\text {LO }}(5.5 \mu \mathrm{~A})} \\
& \mathrm{R}_{\text {FB }}=\left(\mathrm{R}_{\mathrm{HI}}\right)\left(\mathrm{V}_{\text {OUT }} / \Delta \mathrm{V}\right)
\end{aligned}
$$

25 k suggested for $\mathrm{R}_{\mathrm{L} 0}$
$\mathrm{V}_{\text {IN }}=$ Input voltage at which switching stops as input voltage descends to trip level
$\Delta \mathrm{V}=$ Hysteresis in input voltage level
Example: output voltage is 5 V , switching is to stop if input voltage drops below 12 V and should not restart unless input rises back to $13.5 \mathrm{~V} . \Delta \mathrm{V}$ is therefore 1.5 V and $V_{I N}=12 \mathrm{~V}$. Let $\mathrm{R}_{\mathrm{L} O}=25 \mathrm{k}$.

$$
\begin{aligned}
R_{H I} & =\frac{25 k[12-2.38(1.5 / 5+1)+1.5]}{2.38-25 k(5.5 \mu \mathrm{~A})} \\
& =\frac{25 \mathrm{k}(10.41)}{2.24}=116 \mathrm{k} \\
R_{\text {FB }} & =116 \mathrm{k}(5 / 1.5)=387 \mathrm{k}
\end{aligned}
$$

## SYNCHRONIZING

The SYNC input must pass from a logic level low, through the maximum synchronization threshold with a duty cycle between $10 \%$ and $90 \%$. The input can be driven directly from a logic level output. The synchronizing range is equal to initial operating frequency up to 700 kHz . This means that minimum practical sync frequency is equal to the worst-case high self-oscillating frequency ( 228 kHz ), not the typical operating frequency of 200kHz. Caution should be used when synchronizing above 265 kHz because at higher sync frequencies the amplitude of the internal slope
compensation used to prevent subharmonic switching is reduced. This type of subharmonic switching only occurs at input voltages less than twice output voltage. Higher inductor values will tend to eliminate this problem. See Frequency Compensation section for a discussion of an entirely different cause of subharmonic switching before assuming that the cause is insufficient slope compensation. Application Note 19 has more details on the theory of slope compensation.
At power-up, when $V_{C}$ is being clamped by the FB pin (see Figure 2, Q2), the sync function is disabled. This allows the frequency foldback to operate in the shorted output condition. During normal operation, switching frequency is controlled by the internal oscillator until the FB pin reaches 0.6 V , after which the SYNC pin becomes operational. If no synchronization is required, this pin should be connected to ground.

## LAYOUT CONSIDERATIONS

As with all high frequency switchers, when considering layout, care must be taken in order to achieve optimal electrical, thermal and noise performance. For maximum efficiency, switch rise and fall times are typically in the nanosecond range. To prevent noise both radiated and conducted, the high speed switching current path, shown in Figure 5, must be kept as short as possible. This is implemented in the suggested layout of Figure 6. Shortening this path will also reduce the parasitic trace inductance of approximately $25 \mathrm{nH} / \mathrm{inch}$. At switch off, this parasitic inductance produces a flyback spike across the LT1766 switch. When operating at higher currents and input voltages, with poor layout, this spike can generate voltages across the LT1766 that may exceed its absolute maximum


Figure 5. High Speed Switching Path

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Figure 7. Switch Node Resonance
switch off spike will also cause the SW node to go below ground. The LT1766 has special circuitry inside which mitigates this problem, but negative voltages over 0.8 V lasting longer than 10 ns should be avoided. Note that 100MHz oscilloscopes are barely fast enough to see the details of the falling edge overshoot in Figure 7.
A second, much lower frequency ringing is seen during switch off time if load current is low enough to allow the inductor current to fall to zero during part of the switch off time (see Figure 8). Switch and diode capacitance resonate with the inductor to form damped ringing at 1 MHz to 10 MHz . This ringing is not harmful to the regulator and it has not been shown to contribute significantly to EMI. Any attempt to damp it with a resistive snubber will degrade efficiency.

## THERMAL CALCULATIONS

Power dissipation in the LT1766 chip comes from four sources: switch DC loss, switch AC loss, boost circuit current, and input quiescent current. The following formulas show how to calculate each of these losses. These formulas assume continuous mode operation, so they should not be used for calculating efficiency at light load currents.

Switch Ioss:

$$
P_{S W}=\frac{R_{\text {SW }}\left(\mathrm{l}_{\text {OUT }}\right)^{2}\left(\mathrm{~V}_{\text {OUT }}\right)}{\mathrm{V}_{\text {IN }}}+\mathrm{t}_{\text {EFF }}(1 / 2)\left(\mathrm{l}_{\text {OUT }}\right)\left(\mathrm{V}_{\text {IN }}\right)(\mathrm{f})
$$



Figure 8. Discontinuous Mode Ringing
Boost current loss:

$$
P_{\text {BOOST }}=\frac{V_{\text {OUT }}{ }^{2}\left(l_{\text {OUT }} / 36\right)}{V_{\text {IN }}}
$$

Quiescent current loss:
$P_{Q}=V_{\text {IN }}(0.0015)+V_{\text {OUT }}(0.003)$
$\mathrm{R}_{\text {SW }}=$ Switch resistance $(\approx 0.3)$ hot
$t_{\text {EFF }}=$ Effective switch current/voltage overlap time

$$
=\left(t_{r}+t_{f}+t_{l r}+t_{l f}\right)
$$

$\mathrm{t}_{\mathrm{r}}=\left(\mathrm{V}_{\mathrm{IN}} / 1.2\right) \mathrm{ns}$
$\mathrm{t}_{\mathrm{f}}=\left(\mathrm{V}_{\mathrm{IN}} / 1.7\right) \mathrm{ns}$
$\mathrm{t}_{\mathrm{Ir}}=\mathrm{t}_{\mathrm{lf}}=\left(\mathrm{l}_{\text {OUT }} / 0.05\right) \mathrm{ns}$
$f=$ Switch frequency
Example: with $\mathrm{V}_{\text {IN }}=40 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=5 \mathrm{~V}$ and $\mathrm{I}_{\text {OUT }}=1 \mathrm{~A}$ :

$$
\left.\begin{array}{rl}
\mathrm{P}_{\mathrm{SW}} & =\frac{(0.3)(1)^{2}(5)}{40}+\left(97 \cdot 10^{-9}\right)(1 / 2)(1)(40)\left(200 \cdot 10^{3}\right) \\
& =0.04+0.388=0.43 \mathrm{~W}
\end{array}\right\}
$$

$$
P_{Q}=40(0.0015)+5(0.003)=0.08 \mathrm{~W}
$$

Total power dissipation in the IC is given by:

$$
\begin{aligned}
P_{\text {TOT }} & =P_{S W}+P_{\text {BOOST }}+P_{Q} \\
& =0.43 \mathrm{~W}+0.02 \mathrm{~W}+0.08 \mathrm{~W}=0.53 \mathrm{~W}
\end{aligned}
$$

## LT1766/LT1766-5

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Thermal resistance for the LT1766 packages is influenced by the presence of internal or backside planes.
SSOP (GN16) Package: With a full plane under the GN16 package, thermal resistance will be about $85^{\circ} \mathrm{C} / \mathrm{W}$.
TSSOP (Exposed Pad) Package: With a full plane under the TSSOP package, thermal resistance will be about $45^{\circ} \mathrm{C} / \mathrm{W}$.
To calculate die temperature, use the proper thermal resistance number for the desired package and add in worst-case ambient temperature:

$$
\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\mathrm{A}}+\left(\theta_{\mathrm{JA}} \bullet \mathrm{P}_{\mathrm{TOT}}\right)
$$

When estimating ambient, remember the nearby catch diode and inductor will also be dissipating power:

$$
P_{\text {DIODE }}=\frac{\left(V_{F}\right)\left(V_{\text {IN }}-V_{\text {OUT }}\right)\left(I_{\text {LOAD }}\right)}{V_{\text {IN }}}
$$

$V_{F}=$ Forward voltage of diode (assume 0.63 V at 1 A )

$$
\begin{aligned}
& P_{\text {DIODE }}=\frac{(0.63)(40-5)(1)}{40}=0.55 \mathrm{~W} \\
& \text { PINDUCTOR }=\left(\mathrm{l}_{\text {LOAD }}\right)^{2}\left(R_{L}\right)
\end{aligned}
$$

$$
\mathrm{R}_{\mathrm{L}}=\text { Inductor } \mathrm{DC} \text { resistance (assume } 0.1 \Omega \text { ) }
$$

$$
\operatorname{PindUCTOR~}(1)^{2}(0.1)=0.1 \mathrm{~W}
$$

Only a portion of the temperature rise in the external inductor and diode is coupled to the junction of the LT1766. Based on empirical measurements the thermal effect on LT1766 junction temperature due to power dissipation in the external inductor and catch diode can be calculated as:

$$
\Delta T_{J}(\text { LT1766 }) \approx\left(\mathrm{P}_{\text {DIODE }}+\mathrm{P}_{\text {Inductor }}\right)\left(10^{\circ} \mathrm{C} / \mathrm{W}\right)
$$

Using the example calculations for LT1766 dissipation, the LT1766 die temperature will be estimated as:

$$
\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\mathrm{A}}+\left(\theta_{\mathrm{JA}} \bullet \mathrm{P}_{\mathrm{TOT}}\right)+\left[10 \bullet\left(\mathrm{P}_{\mathrm{DIODE}}+\mathrm{P}_{\text {INDUCTOR }}\right)\right]
$$

With the GN16 package $\left(\theta_{\mathrm{JA}}=85^{\circ} \mathrm{C} / \mathrm{W}\right)$, at an ambient temperature of $60^{\circ} \mathrm{C}$ :

$$
T_{J}=60+(85 \cdot 0.53)+(10 \cdot 0.65)=112^{\circ} \mathrm{C}
$$

With the TSSOP package ( $\left.\theta_{\mathrm{JA}}=45^{\circ} \mathrm{C} / \mathrm{W}\right)$, at an ambient temperature of $60^{\circ} \mathrm{C}$ :

$$
T_{J}=60+(45 \cdot 0.53)+(10 \bullet 0.65)=90^{\circ} \mathrm{C}
$$

Die temperature can peak for certain combinations of $\mathrm{V}_{\text {IN }}$, $V_{\text {OUT }}$ and load current. While higher $\mathrm{V}_{\text {IN }}$ gives greater switch AC Iosses, quiescent and catch diode losses, a lower $V_{\text {IN }}$ may generate greater losses due to switch DC losses. In general, the maximum and minimum $\mathrm{V}_{\text {IN }}$ levels should be checked with maximum typical load current for calculation of the LT1766 die temperature. If a more accurate die temperature is required, a measurement of the SYNC pin resistance (to GND) can be used. The SYNC pin resistance can be measured by forcing a voltage no greater than 0.5 V at the pin and monitoring the pin current over temperature in an oven. This should be done with minimal device power (low $\mathrm{V}_{\mathrm{IN}}$ and no switching $\left(V_{C}=0 V\right)$ ) in order to calibrate SYNC pin resistance with ambient (oven) temperature.

Note: Some of the internal power dissipation in the IC, due to BOOST pin voltage, can be transferred outside of the IC to reduce junction temperature, by increasing the voltage drop in the path of the boost diode D2 (see Figure 9). This reduction of junction temperature inside the IC will allow higher ambient temperature operation for a given set of conditions. BOOST pin circuitry dissipates power given by:

$$
P_{\text {DISS(BOOST }}=\frac{V_{\text {OUT }} \cdot\left(\mathrm{I}_{\mathrm{SW}} / 36\right) \cdot \mathrm{V}_{\mathrm{C} 2}}{\mathrm{~V}_{\text {IN }}}
$$

Typically $\mathrm{V}_{\mathrm{C} 2}$ (the boost voltage across the capacitor C 2 ) equals Vout. This is because diodes D1 and D2 can be considered almost equal, where:

$$
V_{C 2}=V_{0 U T}-V_{F D 2}-\left(-V_{F D 1}\right)=V_{\text {OUT }}
$$

Hence the equation used for boost circuitry power dissipation given in the previous Thermal Calculations section is stated as:

$$
P_{\mathrm{DISS}(\mathrm{BOOST})}=\frac{\mathrm{V}_{\text {OUT }} \cdot\left(\mathrm{I}_{\mathrm{SW}} / 36\right) \cdot \mathrm{V}_{\text {OUT }}}{\mathrm{V}_{\text {IN }}}
$$

Here it can be seen that boost power dissipation increases as the square of $\mathrm{V}_{\text {out }}$. It is possible, however, to reduce $\mathrm{V}_{\mathrm{C} 2}$ below $\mathrm{V}_{\text {OUT }}$ to save power dissipation by increasing the voltage drop in the path of D2. Care should be taken that $V_{C 2}$ does not fall below the minimum 3.3 V boost

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voltage required for full saturation of the internal power switch. For output voltages of $5 \mathrm{~V}, \mathrm{~V}_{\mathrm{C} 2}$ is approximately 5 V . During switch turn on, $\mathrm{V}_{\mathrm{C} 2}$ will fall as the boost capacitor C2 is dicharged by the boost pin. In the previous Boost Pin section, the value of C 2 was designed for a 0.7 V droop in $V_{C 2}=V_{\text {DROOP }}$. Hence, an output voltage as low as 4 V would still allow the minimum 3.3 V for the boost function using the C2 capacitor calculated. If a target output voltage of 12 V is required, however, an excess of 8 V is placed across the boost capacitor which is not required for the boost function but still dissipates additional power.
What is required is a voltage drop in the path of D2 to achieve minimal power dissipation while still maintaining minimum boost voltage across C2. A zener, D4, placed in series with D2 (see Figure 9), drops voltage to C2.
Example : the BOOST pin power dissipation for a 20 V input to 12 V output conversion at 1 A is given by:


Figure 9. Boost Pin, Diode Selection

$$
\mathrm{P}_{\text {BOOST }}=\frac{12 \bullet(1 / 36) \bullet 12}{20}=0.2 \mathrm{~W}
$$

If a 7 V zener D 4 is placed in series with D 2 , then power dissipation becomes :

$$
\mathrm{P}_{\mathrm{BOOST}}=\frac{12 \cdot(1 / 36) \cdot 5}{20}=0.084 \mathrm{~W}
$$

For an FE package with thermal resistance of $45^{\circ} \mathrm{C} / \mathrm{W}$, ambient temperature savings would be, T(ambient) savings $=0.116 \mathrm{~W} \cdot 45^{\circ} \mathrm{C} / \mathrm{W}=5 \mathrm{c}$. For a GN Package with thermal resistance of $85^{\circ} \mathrm{C} / \mathrm{W}$, ambient temperature savings would be $\mathrm{T} /($ ambient $)$ savings $=0.116 \cdot 85^{\circ} \mathrm{C} / \mathrm{W}=$ 10 c . The 7 V zener should be sized for excess of 0.116 W operation. The tolerances of the zener should be considered to ensure minimum $V_{C 2}$ exceeds $3.3 \mathrm{~V}+\mathrm{V}_{\text {DR00p }}$.

## Input Voltage vs Operating Frequency Considerations

The absolute maximum inputsupply voltage for the LT1766 is specified at 60 V . This is based solely on internal semiconductor junction breakdown effects. Due to internal power dissipation, the actual maximum $V_{\text {IN }}$ achievable in a particular application may be less than this.

A detailed theoretical basis for estimating internal power Ioss is given in the section, Thermal Considerations. Note that AC switching loss is proportional to both operating frequency and output current. The majority of AC switching loss is also proportional to the square of input voltage. For example, while the combination of $\mathrm{V}_{\text {IN }}=40 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=$ 5 V at 1 A and $\mathrm{f}_{0 S \mathrm{C}}=200 \mathrm{kHz}$ may be easily achievable, simultaneously raising $\mathrm{V}_{\text {IN }}$ to 60 V and $\mathrm{f}_{\text {OSC }}$ to 700 kHz is not possible. Nevertheless, input voltage transients up to 60 V can usually be accommodated, assuming the resulting increase in internal dissipation is of insufficient time duration to raise die temperature significantly.

A second consideration is controllability. A potential limitation occurs with a high step-down ratio of $\mathrm{V}_{\text {IN }}$ to $\mathrm{V}_{\text {OUT }}$, as this requires a correspondingly narrow minimum switch on time. An approximate expression for this (assuming continuous mode operation) is given as follows:

$$
\operatorname{Min} t_{O N}=\frac{V_{O U T}+V_{F}}{V_{I N}\left(f_{O S C}\right)}
$$

where:
$\mathrm{V}_{\text {IN }}=$ input voltage
$V_{\text {OUT }}=$ output voltage
$V_{F}=$ Schottky diode forward drop
$\mathrm{f}_{\mathrm{OSC}}=$ switching frequency
A potential controllability problem arises if the LT1766 is called upon to produce an on time shorter than it is able to produce. Feedback loop action will lower then reduce the

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$V_{C}$ control voltage to the point where some sort of cycleskipping or odd/even cycle behavior is exhibited.
In summary:

1. Be aware that the simultaneous requirements of high $\mathrm{V}_{\text {IN }}$, high $\mathrm{I}_{\text {OUT }}$ and high $\mathrm{f}_{\text {OSc }}$ may not be achievable in practice due to internal dissipation. The Thermal Considerations section offers a basis to estimate internal power. In questionable cases a prototype supply should be built and exercised to verify acceptable operation.
2. The simultaneous requirements of high $\mathrm{V}_{\text {IN }}$, Iow $\mathrm{V}_{\text {OUT }}$ and high fosc can result in an unacceptably short minimum switch on time. Cycle skipping and/or odd/ even cycle behavior will result although correct output voltage is usually maintained.

## FREQUENCY COMPENSATION

Before starting on the theoretical analysis of frequency response, the following should be remembered-the worse the board layout, the more difficult the circuit will be to stabilize. This is true of almost all high frequency analog circuits, read the Layout Considerations section first. Common layout errors that appear as stability problems are distant placement of input decoupling capacitor and/ or catch diode, and connecting the $\mathrm{V}_{\mathrm{C}}$ compensation to a ground track carrying significant switch current. In addition, the theoretical analysis considers only first order non-ideal component behavior. For these reasons, it is important that a final stability check is made with production layout and components.
The LT1766 uses current mode control. This alleviates many of the phase shift problems associated with the inductor. The basic regulator loop is shown in Figure 10. The LT1766 can be considered as two $\mathrm{g}_{\mathrm{m}}$ blocks, the error amplifier and the power stage.
Figure 11 shows the overall loop response. At the $V_{C}$ pin, the frequency compensation components used are: $R_{C}=2.2 \mathrm{k}, \mathrm{C}_{\mathrm{C}}=0.022 \mu \mathrm{~F}$ and $\mathrm{C}_{\mathrm{F}}=220 \mathrm{pF}$. The output capacitor used is a $100 \mu \mathrm{~F}, 10 \mathrm{~V}$ tantalum capacitor with typical ESR of $100 \mathrm{~m} \Omega$.

The ESR of the tantalum output capacitor provides a useful zero in the loop frequency response for maintaining stabil-


Figure 10. Model for Loop Response


Figure 11. Overall Loop Response
ity. This ESR, however, contributes significantly to the ripple voltage at the output (see Output Ripple Voltage in the Applications Section). It is possible to reduce capacitor size and output ripple voltage by replacing the tantalum output capacitor with a ceramic output capacitor because of its very low ESR. The zero provided by the tantalum output capacitor must now be reinserted back into the loop. Alternatively there may be cases where, even with the tantalum output capacitor, an additional zero is required in the loop to increase phase margin for improved transient response.
A zero can be added into the loop by placing a resistor, $\mathrm{R}_{\mathrm{C}}$, at the $\mathrm{V}_{\mathrm{C}}$ pin in series with the compensation capacitor, $\mathrm{C}_{\mathrm{C}}$ or by placing a capacitor, CFB, between the output and the FB pin.

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When using $R_{C}$, the maximum value has two limitations. First, the combination of output capacitor ESR and R $R_{C}$ may stop the loop rolling off altogether. Second, if the loop gain is not rolled off sufficiently at the switching frequency, output ripple will peturb the $V_{C}$ pin enough to cause unstable duty cycle switching similar to subharmonic oscillations. If needed, an additional capacitor CF can be added across the $\mathrm{R}_{\mathrm{C}} / \mathrm{C}_{\mathrm{C}}$ network from the $\mathrm{V}_{\mathrm{C}}$ pinto ground to further suppress $V_{C}$ ripple voltage.
With a tantalum output capacitor, the LT1766 already includes a resistor, $R_{C}$ and filter capacitor, $C F$, at the $V_{C}$ pin (see Figures 10 and 11) to compensate the loop over the entire $\mathrm{V}_{\text {IN }}$ range (to allow for stable pulse skipping for high $\mathrm{V}_{\text {IN }}-\mathrm{to}-\mathrm{V}_{\text {OUT }}$ ratios $\geq 10$ ). A ceramic output capacitor can still be used with a simple adjustment to the resistor $R_{C}$ for stable operation. (See Ceramic Capacitors section for stabilizing LT1766). If additional phase margin is required, a capacitor, CFB, can be inserted between the output and FB pin but care must be taken for high output voltage applications. Sudden shorts to the output can create unacceptably large negative transients on the FB pin.

For $\mathrm{V}_{\text {IN }}-\mathrm{to}-\mathrm{V}_{\text {OUT }}$ ratios $<10$, higher loop bandwidths are possible by readjusting the frequency compensation components at the $V_{C}$ pin.
When checking loop stability, the circuit should be operated over the applications's full voltage, current and temperature range. Proper loop compensation may be obtained by emperical methods as described in detail in Application Notes 19 and 76.

## CONVERTER WITH BACKUP OUTPUT REGULATOR

In systems with a primary and backup supply, for example, a battery powered device with a wall adapter input, the output of the LT1766 can be held up by the backup supply with the LT1766 input disconnected. In this condition, the SW pin will source current into the $\mathrm{V}_{\text {IN }}$ pin. If the SHDN pin is held at ground, only the shut down current of $25 \mu A$ will be pulled via the SW pin from the second supply. With the SHDN pin floating, the LT1766 will consume its quiescent operating current of 1.5 mA . The $\mathrm{V}_{\text {IN }}$ pin will also source current to any other components connected to the input line. If this load is greater than 10 mA or the input could be shorted to ground, a series Schottky diode must be added, as shown in Figure 12. With these safeguards, the output can be held at voltages up to the $\mathrm{V}_{\text {IN }}$ absolute maximum rating.

## BUCK CONVERTER WITH ADJUSTABLE SOFT-START

Large capacitive loads or high input voltages can cause high input currents at start-up. Figure 13 shows a circuit that limits the $\mathrm{dv} / \mathrm{dt}$ of the output at start-up, controlling the capacitor charge rate. The buck converter is a typical configuration with the addition of R3, R4, $\mathrm{C}_{\mathrm{SS}}$ and Q1. As the output starts to rise, Q1 turns on, regulating switch current via the $\mathrm{V}_{\mathrm{C}}$ pin to maintain a constant dv/dt at the output. Output rise time is controlled by the current through $\mathrm{C}_{S S}$ defined by R4 and Q1's $\mathrm{V}_{\mathrm{BE}}$. Once the output is in regulation, Q1 turns off and the circuit operates normally. R3 is transient protection for the base of Q1.


Figure 12. Dual Source Supply with $25 \mu \mathrm{~A}$ Reverse Leakage

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Using the values shown in Figure 10,

$$
\text { Rise Time }=\frac{\left(47 \cdot 10^{3}\right)\left(15 \cdot 10^{-9}\right)(5)}{0.7}=5 \mathrm{~ms}
$$

The ramp is linear and rise times in the order of 100 ms are possible. Since the circuit is voltage controlled, the ramp rate is unaffected by load characteristics and maximum output current is unchanged. Variants of this circuit can be used for sequencing multiple regulator outputs.

## DUAL OUTPUT SEPIC CONVERTER

The circuit in Figure 14 generates both positive and negative 5 V outputs with a single piece of magnetics. The two inductors shown are actually just two windings on a standard Coiltronics inductor. The topology for the 5 V output is a standard buck converter. The -5 V topology would be a simple flyback winding coupled to the buck converter if C4 were not present. C4 creates a SEPIC (single-ended primary inductance converter) topology which improves regulation and reduces ripple current in L1. Without C4, the voltage swing on L1B compared to L1A would vary due to relative loading and coupling losses. C4 provides a low impedance path to maintain an equal voltage swing in L1B, improving regulation. In a flyback converter, during switch ontime, all the converter's energy is stored in L1A only, since no current flows in L1B.


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$I_{p}=$ Maximum rated switch current
$\mathrm{V}_{\mathrm{IN}}=$ Minimum input voltage
$\mathrm{V}_{\text {OUT }}=$ Output voltage
$V_{F}=$ Catch diode forward voltage
$0.3=$ Switch voltage drop at 1.5 A
Example: with $\mathrm{V}_{\text {IN }(\operatorname{MIN})}=5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=12 \mathrm{~V}, \mathrm{~L}=18 \mu \mathrm{H}$, $V_{F}=0.63 \mathrm{~V}, I_{P}=1.5 \mathrm{~A}: I_{\mathrm{MAX}}=0.280 \mathrm{~A}$.

## OUTPUT DIVIDER

Refer to Applications Information Feedback Pin Functions to calculate R1 and R2 for the (negative) output voltage (from Table 1).


* INCREASE L1 TO $30 \mu \mathrm{H}$ OR $60 \mu \mathrm{H}$ FOR HIGHER CURRENT APPLICATIONS. SEE APPLICATIONS INFORMATION
** MAXIMUM LOAD CURRENT DEPENDS ON MINIMUM INPUT VOLTAGE AND INDUCTOR SIZE. SEE APPLICATIONS INFORMATION
$\dagger$ FOR VIN > 44V AND VOUT = -12V, ADDITIONAL VOLTAGE DROP IN THE PATH OF D2 IS REQUIRED TO ENSURE BOOST PIN MAXIMUM RATING IS NOT EXCEEDED. SEE APPLICATIONS INFORMATION (BOOST PIN VOLTAGE)

Figure 15. Positive-to-Negative Converter

## Inductor Value

The criteria for choosing the inductor is typically based on ensuring that peak switch current rating is not exceeded. This gives the lowest value of inductance that can be used, but in some cases (lower output load currents) it may give a value that creates unnecessarily high output ripple voltage.
The difficulty in calculating the minimum inductor size needed is that you must first decide whether the switcher will be in continuous or discontinuous mode at the critical point where switch current reaches 1.5A. The first step is to use the following formula to calculate the load current above which the switcher must use continuous mode. If your load current is less than this, use the discontinuous mode formula to calculate minimum inductor needed. If load current is higher, use the continuous mode formula.

Output current where continuous mode is needed:

$$
I_{\text {CONT }}>\sqrt{\frac{\left(V_{\text {IN }}\right)^{2}\left(I_{P}\right)^{2}}{4\left(V_{\text {IN }}+V_{\text {OUT }}\right)\left(V_{\text {IN }}+V_{\text {OUT }}+V_{F}\right)}}
$$

Minimum inductor discontinuous mode:

$$
L_{\text {MIIN }}=\frac{2\left(V_{\text {OUT }}\right)\left(l_{\text {OUT }}\right)}{(f)\left(I_{P}\right)^{2}}
$$

Minimum inductor continuous mode:

$$
L_{\text {MIN }}=\frac{\left(V_{\text {IN }}\right)\left(V_{\text {OUT }}\right)}{2(f)\left(V_{\text {IN }}+V_{\text {OUT }}\left[I_{\text {P }}-I_{\text {OUT }}\left(1+\frac{\left(V_{\text {OUT }}+V_{F}\right)}{V_{\text {IN }}}\right)\right]\right.}
$$

For a 40V to -12V converter using the LT1766 with peak switch current of 1.5 A and a catch diode of 0.63 V :

$$
\mathrm{I}_{\mathrm{CONT}}>\sqrt{\frac{(40)^{2}(1.5)^{2}}{4(40+12)(40+12+0.63)}}=0.573 \mathrm{~A}
$$

For a load current of 0.25 A , this says that discontinuous mode can be used and the minimum inductor needed is found from:

$$
\mathrm{L}_{\mathrm{MIN}}=\frac{2(12)(0.25)}{\left(200 \cdot 10^{3}\right)(1.5)^{2}}=13.3 \mu \mathrm{H}
$$

In practice, the inductor should be increased by about $30 \%$ over the calculated minimum to handle losses and variations in value. This suggests a minimum inductor of $18 \mu \mathrm{H}$ for this application.

## Ripple Current in the Input and Output Capacitors

Positive-to-negative converters have high ripple current in the input capacitor. For long capacitor lifetime, the RMS value of this current must be less than the high frequency ripple current rating of the capacitor. The following formula will give an approximate value for RMS ripple current. This formula assumes continuous mode and large inductor value. Small inductors will give somewhat higher ripple current, especially in discontinuous mode. The exact formulas are very complex and appear in Application Note 44, pages 29 and 30 . For our purposes here a fudge factor (ff) is used. The value for ff is about 1.2 for higher

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load currents and $L \geq 15 \mu \mathrm{H}$. It increases to about 2.0 for smaller inductors at lower load currents.

$$
\text { Input Capacitor } I_{\text {RMS }}=(\mathrm{ff})\left(\mathrm{l}_{\mathrm{OUT}}\right) \sqrt{\frac{\mathrm{V}_{\text {OUT }}}{\mathrm{V}_{\text {IN }}}}
$$

$\mathrm{ff}=1.2$ to 2.0
The output capacitor ripple current for the positive-tonegative converter is similar to that for a typical buck regulator-it is a triangular waveform with peak-to-peak value equal to the peak-to-peak triangular waveform of the inductor. The low output ripple design in Figure 15 places the input capacitor between $\mathrm{V}_{\text {IN }}$ and the regulated negative output. This placement of the input capacitor significantly reduces the size required for the output capacitor (versus placing the input capacitor between $\mathrm{V}_{\mathrm{IN}}$ and ground).
The peak-to-peak ripple current in both the inductor and output capacitor (assuming continuous mode) is:

$$
\begin{aligned}
& I_{P-P}=\frac{D C \cdot V_{\text {IN }}}{f \cdot L} \\
& D C=\text { Duty } C y C l e=\frac{V_{\text {OUT }}+V_{F}}{V_{\text {OUT }}+V_{\text {IN }}+V_{F}} \\
& I_{\text {COUT }}(\text { RMS })=\frac{I_{p-P}}{\sqrt{12}}
\end{aligned}
$$

The output ripple voltage for this configuration is as low as the typical buck regulator based predominantly on the inductor's triangular peak-to-peak ripple current and the ESR of the chosen capacitor (see Output Ripple Voltage in Applications Information).

## Diode Current

Average diode current is equal to load current. Peak diode current will be considerably higher.
Peak diode current:

> Continuous Mode $=$
> $\mathrm{I}_{\text {OUT }} \frac{\left(\mathrm{V}_{\text {IN }}+V_{\text {OUT }}\right)}{\mathrm{V}_{\text {IN }}}+\frac{\left(\mathrm{V}_{\text {IN }}\right)\left(\mathrm{V}_{\text {OUT }}\right)}{2(\mathrm{~L})(\mathrm{f})\left(\mathrm{V}_{\text {IN }}+V_{\text {OUT }}\right)}$

Discontinuous Mode $=\sqrt{\frac{2\left(\text { lout }^{\prime}\right)\left(V_{\text {OUT }}\right)}{(\mathrm{L})(\mathrm{f})}}$

Keep in mind that during start-up and output overloads, average diode current may be much higher than with normal loads. Care should be used if diodes rated less than 1 A are used, especially if continuous overload conditions must be tolerated.

## BOOST Pin Voltage

To ensure that the BOOST pin voltage does not exceed its absolute maximum rating of 68 V with respect to device GND pin voltage, care should be taken in the generation of boost voltage. For the conventional method of generating boost voltage, shown in Figure 1, the voltage at the BOOST pin during switch on time is approximately given by:

$$
V_{\text {BOOST }}(G N D \text { pin })=\left(V_{\text {IN }}-V_{\text {GNDPIN }}\right)+V_{C 2}
$$

where:

$$
\begin{aligned}
V_{C 2} & =(D 2+)-V_{D 2}-(D 1+)+V_{D 1} \\
& =\text { voltage across the "boost" capacitor }
\end{aligned}
$$

For the positive-to-negative converter shown in Figure 15, the conventional Buck output node is grounded (D2+) $=0 \mathrm{~V}$ and the catch diode ( $\mathrm{D} 1+$ ) is connected to the negative output $=\mathrm{V}_{\text {OUT }}=-12 \mathrm{~V}$. Absolute maximum ratings should also be observed with the GND pin now at -12 V . It can be seen that for $V_{D 1}=V_{D 2}$ :

$$
V_{C 2}=(\mathrm{D} 2+)-(\mathrm{D} 1+)=\left|\mathrm{V}_{\text {OUT }}\right|=12 \mathrm{~V}
$$

The maximum $\mathrm{V}_{\text {IN }}$ voltage allowed for the device (GND pin at -12 V ) is 48 V .
The maximum $V_{I N}$ voltage allowed without exceeding the BOOST pin voltage absolute maximum rating is given by:

$$
\begin{aligned}
& V_{\text {IN(MAX })}=\text { Boost }(\text { Max })+\left(V_{G N D P I N ~}\right)-V_{C 2} \\
& V_{\text {IN(MAX })}=68+(-12)-12=44 \mathrm{~V}
\end{aligned}
$$

To increase usable $\mathrm{V}_{\text {IN }}$ voltage, $\mathrm{V}_{\mathrm{C} 2}$ must be reduced. This can be achieved by placing a zener diode $\mathrm{V}_{\mathrm{Z} 1}$ (anode at $\mathrm{C} 2+$ ) in series with D2.
Note: A maximum limit on $\mathrm{V}_{\mathrm{Z1}}$ must be observed to ensure a minimum $V_{C 2}$ is maintained on the "boost" capacitor; referred to as "V $\mathrm{V}_{\text {BOOST(MIN)" }}$ " in the Electrical Characteristics.

## PACKAGE DESCRIPTION



## LT1766/LT1766-5

## RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :---: | :---: | :---: |
| LT1074/LT1074HV | 4.4A (Iout), 100kHz, High Efficiency Step-Down DC/DC Converters | $\mathrm{V}_{\text {IN: }}: 7.3 \mathrm{~V}$ to $45 \mathrm{~V} / 64 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN): }}: 2.21 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 8.5 \mathrm{~mA}$, $I_{S D}: 10 \mu A, D D-5 / 7$, TO220-5/7 |
| LT1076/LT1076HV | 1.6A (Iout), 100kHz, High Efficiency Step-Down DC/DC Converters | $\mathrm{V}_{\text {IN: }}: 7.3 \mathrm{~V}$ to $45 \mathrm{~V} / 64 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN): }}: 2.21 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 8.5 \mathrm{~mA}$, $\mathrm{I}_{\mathrm{SD}}: 10 \mu \mathrm{~A}, \mathrm{DD}-5 / 7$, TO220-5/7 |
| LT1616 | 500 mA (IOUT), 1.4 MHz , High Efficiency Step-Down DC/DC Converter | $\begin{aligned} & \mathrm{V}_{\text {IN: }}: 3.6 \mathrm{~V} \text { to } 25 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}: 1.25 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 1.9 \mathrm{~mA} \text {, } \\ & \mathrm{I}_{\mathrm{SD}}:<1 \mu \mathrm{~A} \text {, ThinSOTM } \end{aligned}$ |
| LT1676 | $60 \mathrm{~V}, 440 \mathrm{~mA}$ (I $\mathrm{I}_{\text {OUT }}$ ), 100 kHz , High Efficiency Step-Down DC/DC Converter | $\begin{aligned} & \mathrm{V}_{\text {IN: }}: 7.4 \mathrm{~V} \text { to } 60 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}: 1.24 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 3.2 \mathrm{~mA}, \\ & \mathrm{I}_{\mathrm{SD}}: 2.5 \mu \mathrm{~A}, \mathrm{~S} 8 \end{aligned}$ |
| LT1765 | $25 \mathrm{~V}, 2.75 \mathrm{~A}$ (Iout), 1.25 MHz , High Efficiency Step-Down DC/DC Converter | $\mathrm{V}_{\text {IN }}: 3 \mathrm{~V}$ to $25 \mathrm{~V}, \mathrm{~V}_{\text {OUt(Min) }}$ : $1.20 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 1 \mathrm{~mA}$, $\mathrm{I}_{\mathrm{SD}}: 15 \mu \mathrm{~A}, \mathrm{~S} 8, \mathrm{TSSOP} 16 \mathrm{E}$ |
| LT1766 | 60V, 1.2A (Iout), 200kHz, High Efficiency Step-Down DC/DC Converter | $\mathrm{V}_{\mathrm{IN}}: 5.5 \mathrm{~V}$ to $60 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}: 1.20 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 2.5 \mathrm{~mA}$, $I_{\text {SD }}: 25 \mu \mathrm{~A}, \mathrm{TSSOP} 16 / \mathrm{E}$ |
| LT1767 | $25 \mathrm{~V}, 1.2 \mathrm{~A}$ (lout), 1.25MHz, High Efficiency Step-Down DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 3 \mathrm{~V}$ to 25 V , $\mathrm{V}_{\text {OUT(MIIN): }} 1.20 \mathrm{~V}$, $\mathrm{IQ}_{\mathrm{Q}}: 1 \mathrm{~mA}$, $\mathrm{I}_{\mathrm{sD}}$ : $6 \mathrm{HA}, \mathrm{MS} 8 / \mathrm{E}$ |
| LT1776 | $40 \mathrm{~V}, 550 \mathrm{~mA}$ (I $\mathrm{I}_{\text {Out }}$ ), 200kHz, High Efficiency Step-Down DC/DC Converter | $\begin{aligned} & \mathrm{V}_{\text {IN: }}: 7.4 \mathrm{~V} \text { to } 40 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}: 1.24 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 3.2 \mathrm{~mA}, \\ & \mathrm{I}_{\mathrm{SD}}: 30 \mu \mathrm{~A}, \mathrm{~N} 8, \mathrm{~S} 8 \end{aligned}$ |
| LT1940 | Dual Output 1.4A (IOUT), Constant 1.1MHz, High Efficiency Step-Down DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 3 \mathrm{~V}$ to $25 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN): }}: 1.20 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 2.5 \mathrm{~mA}$, $\mathrm{I}_{\mathrm{SD}}:<1 \mu \mathrm{~A}, \mathrm{TSSOP}-16 \mathrm{E}$ |
| LT1956 | 60V, 1.2A (Iout), 500kHz, High Efficiency Step-Down DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 5.5 \mathrm{~V}$ to $60 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MII): }}: 1.20 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 2.5 \mathrm{~mA}$, $\mathrm{I}_{\mathrm{SD}}: 25 \mu \mathrm{~A}, \mathrm{TSSOP} 16 / \mathrm{E}$ |
| LT1976 | $60 \mathrm{~V}, 1.2 \mathrm{~A}$ (Iout), 200kHz, Micropower ( $\mathrm{I}_{\mathrm{Q}}=100 \mu \mathrm{~A}$ ), High Efficiency Step-Down DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 3.3 \mathrm{~V}$ to $60 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}$ : $1.20 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 100 \mu \mathrm{~A}$, $\mathrm{I}_{\mathrm{SD}}:<1 \mu \mathrm{~A}, \mathrm{TSSOP} 16 / \mathrm{E}$ |
| LT3010 | 80V, 50mA, Low Noise Linear Regulator | $\begin{aligned} & \mathrm{V}_{\text {IN : }}: 1.5 \mathrm{~V} \text { to } 80 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN): }} 1.28 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 30 \mu \mathrm{~A}, \\ & \mathrm{I}_{\mathrm{SD}}:<1 \mu \mathrm{~A}, \mathrm{MS} \mathrm{E} \end{aligned}$ |
| LTC3412 | 2.5A (lout), 4MHz, Synchronous Step-Down DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}: 0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 60 \mu \mathrm{~A}$, $\mathrm{I}_{\mathrm{SD}}:<1 \mu \mathrm{~A}$, TSSOP16E |
| LTC3414 | 4A (Iout), 4MHz, Synchronous Step-Down DC/DC Converter | $\begin{aligned} & \mathrm{V}_{\text {IN: }}: 2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}: 0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 64 \mu \mathrm{~A}, \\ & \mathrm{I}_{\mathrm{SD}}:<1 \mu \mathrm{~A}, \mathrm{TSSOP} 20 \mathrm{E} \end{aligned}$ |
| LT3430/LT3431 | 60V, 2.75A (IOUT), 200kHz/500kHz, High Efficiency Step-Down DC/DC Converters | $\mathrm{V}_{\mathrm{IN}}: 5.5 \mathrm{~V}$ to $60 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}: 1.20 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 2.5 \mathrm{~mA}$, $\mathrm{I}_{\mathrm{SD}}: 30 \mu \mathrm{~A}$, TSSOP16E |
| LT3433 | High Voltage, Micropower ( $\mathrm{l}_{\mathrm{Q}}=100 \mu \mathrm{~A}$ ), Buck-Boost DC/DC Converter | $\mathrm{V}_{\text {IN: }}: 4 \mathrm{~V}$ to $60 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 100 \mu \mathrm{~A}, 500 \mathrm{~mA}$ Switch Current, TSSOP16E |
| LTC3727/LTC3727-1 | 36V, 500kHz, High Efficiency Step-Down DC/DC Controllers | $\mathrm{V}_{\text {IN: }}: 4 \mathrm{~V}$ to $36 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN): }}: 0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}: 670 \mu \mathrm{~A}$, $I_{\mathrm{sD}}: 20 \mathrm{~A}$, QFN-32, SSOP-28 |

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